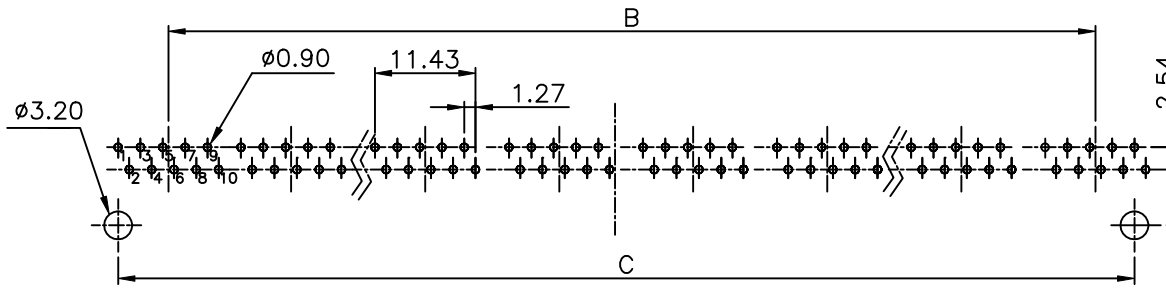


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
△		Design Modify	Synge 8/04/2003	
△		ADD PART NO	Among 11/22/2004	
△		ADD PART NO	sammy 12/24/04	
△		MODIFY DRAWING	LJUXIN 01/28/08	
△		DRAWING Modify	ANKUE 03/21/05	
△		ADD PART NO	WYJ 05/12/05	
△		DRAWING Modify	ANKUE 11/18/05	



PC Board Layout Component Side Shown

**NOTES:**

**ELECTRICAL:**

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP
- CONTACT RESISTANCE : 40 MILLIOHMS MAX. △
- INSULATION RESISTANCE: 1000 MEGOHMSMIN @ 500 VDC. △
- DIELECTRIC STRENGTH : 1000 VAC RMS 60HZ,1MIN.

**MECHANICAL:**

- HOUSING MATERIAL : GLASS FILLED POLYESTER UL 94V-0.
- CONTACT MATERIAL : PHOSPHOR BRONZE  $\phi$ 0.46mm.  
or PHOSPHOR BRONZE t=0.35mm.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN.
- PCB RETENTION PRE-SOLDER: 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

**ENVIRONMENTAL:**

- STORAGE : -40°C TO +85°C.
- OPERATION : 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E560X-XOXOXX

- NO. OF CONTACT
  - 8-8 CONTACTS
  - 1-10 CONTACTS
  - △ 4-4 CONTACTS
  - 0- W/FRE LOGO
  - △ 2- W/O FRE LOGO
- 1- 3u" 2- 6u" 3-15u"  
4-30u" 5-50u" 6-Pd20u"  
△ F- Gold Flash
- 6-ROUND PIN(FRE) Q-ROUND PIN(MAXTOP)  
8-STAMP PIN(FRE) R-STAMP PIN(MAXTOP)
- A-2PORTS  
C-4PORTS  
E-6PORTS  
G-8PORTS

PORTS	DIM "A" ± 0.10 0.20	DIM "B" ± 0.20	DIM "C" ± 0.05	DIM "D" ± 0.15
2	30.48	13.97	25.40	25.40
4	58.42	41.91	53.34	53.34
6	86.36	86.36	81.28	81.28
8	114.30	97.79	109.22	109.22

← MM (INCH) →	DFTO SHINE	DATE 3/31/01
TOLERANCES EXCEPT AS NOTED	CHKD YUKI	DATE 2008/11/17
MM	MFO	DATE
.0 ± 0.2 ±	APPVLSUHENG	DATE 2008/11/17
.00 ± 0.15 ±	MATERIAL :	
.000 ± 0.075 ±	QT'Y :	
ANGLES ± 0.5	FINISH :	
THIRD ANGLE PROJECTION	SCALE :	

FULL RISE ELECTRONIC CO., LTD		
TITLE 11.5 SIDE ENTRY PCB GANG JACK 10P		
DRAWING NO. GE563062	SIZE A3	REV 7
/PART NO. SEE NOTE		
DO NOT SCALE DRAWING	SHEET	OF